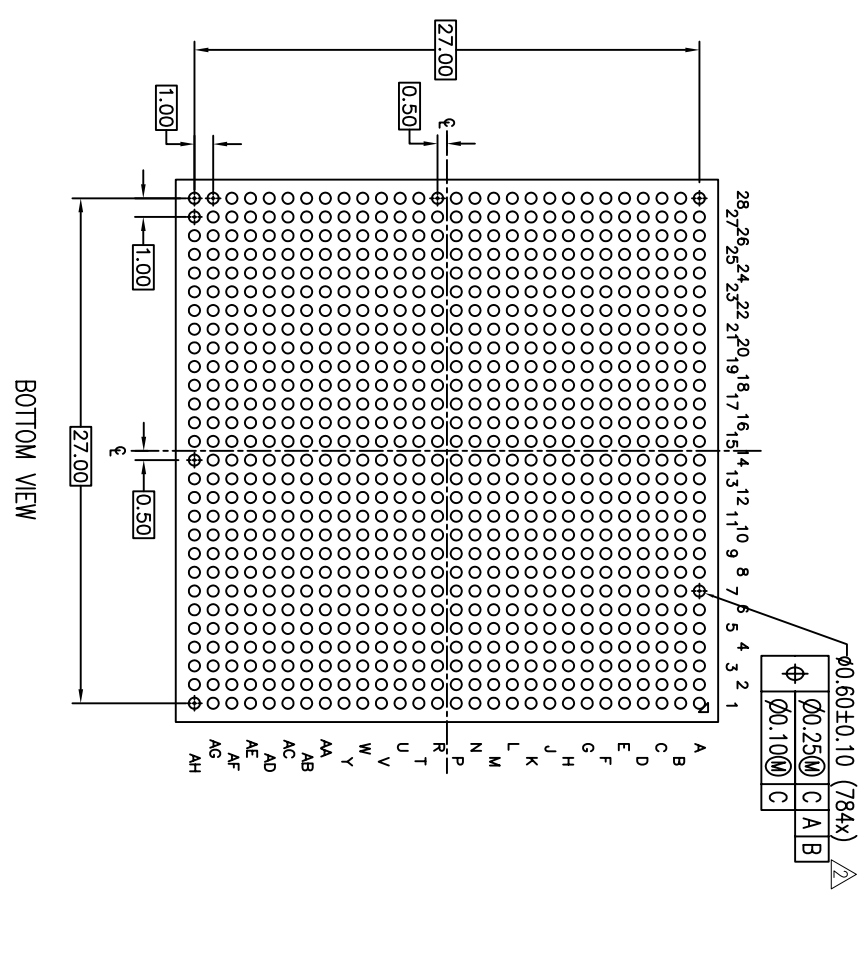
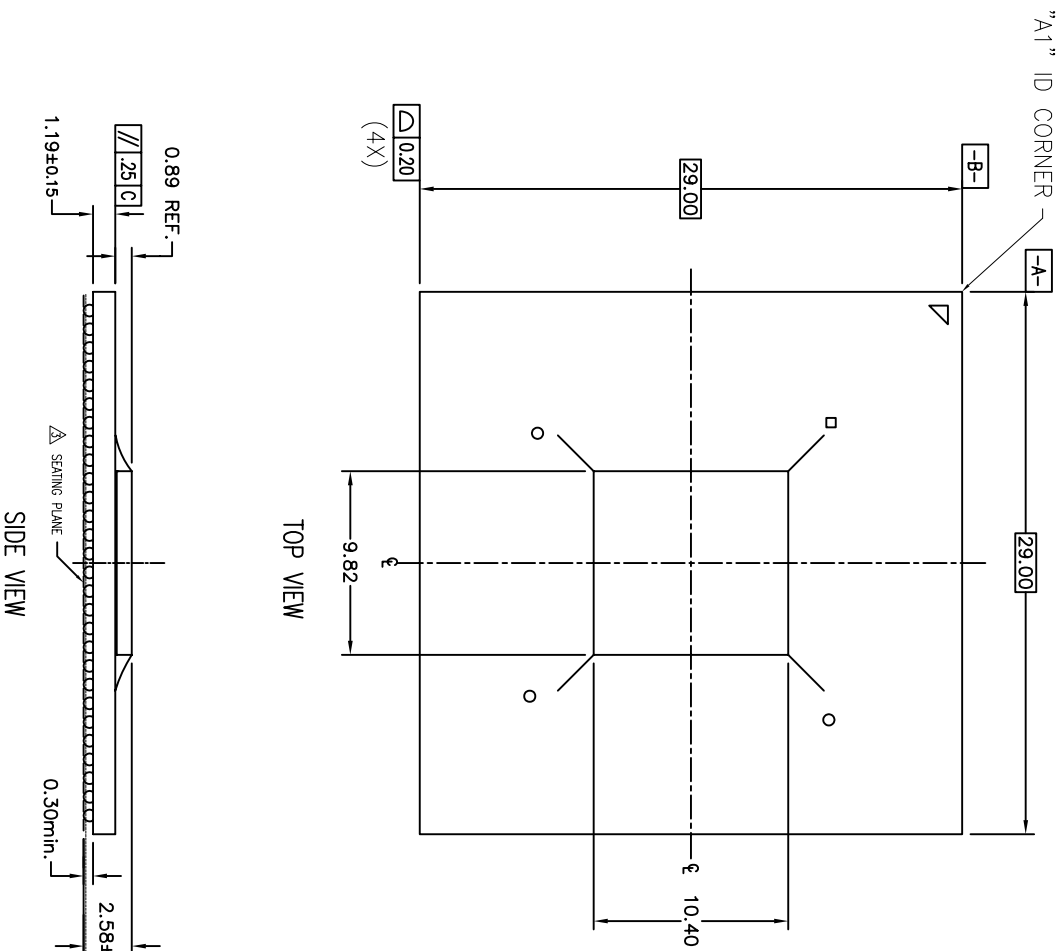


NOTES:

- 1 ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5M-1994 DIMENSION IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER, PARALLEL TO PRIMARY DATUM -C-
- 2 SEATING PLANE AND PRIMARY DATUM -C- ARE DEFINED BY THE CONTACT POINTS OF THREE OR MORE SOLDER BALLS THAT SUPPORT THE DEVICE WHEN PLACED ON A TOP OF A PLANAR SURFACE.
- 4 ALL DIMENSIONS ARE IN MILLIMETERS



REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	06/02/10	K. STAHN
01	PACKAGE THICKNESS UPDATED	06/15/10	K. STAHN
02	DIMENSIONS ADDED AND FORMAT UPDATED	10/06/10	M.ROY
03	COMBINE PCD & LAND PATTERN	06/03/13	K. STAHN

TOLERANCES UNLESS SPECIFIED
 DECIMAL ±
 ANGULAR ±

APPROVALS DATE DATE
 DRAWN 07/08/09
 CHECKED

XXXXX
 XXXXX

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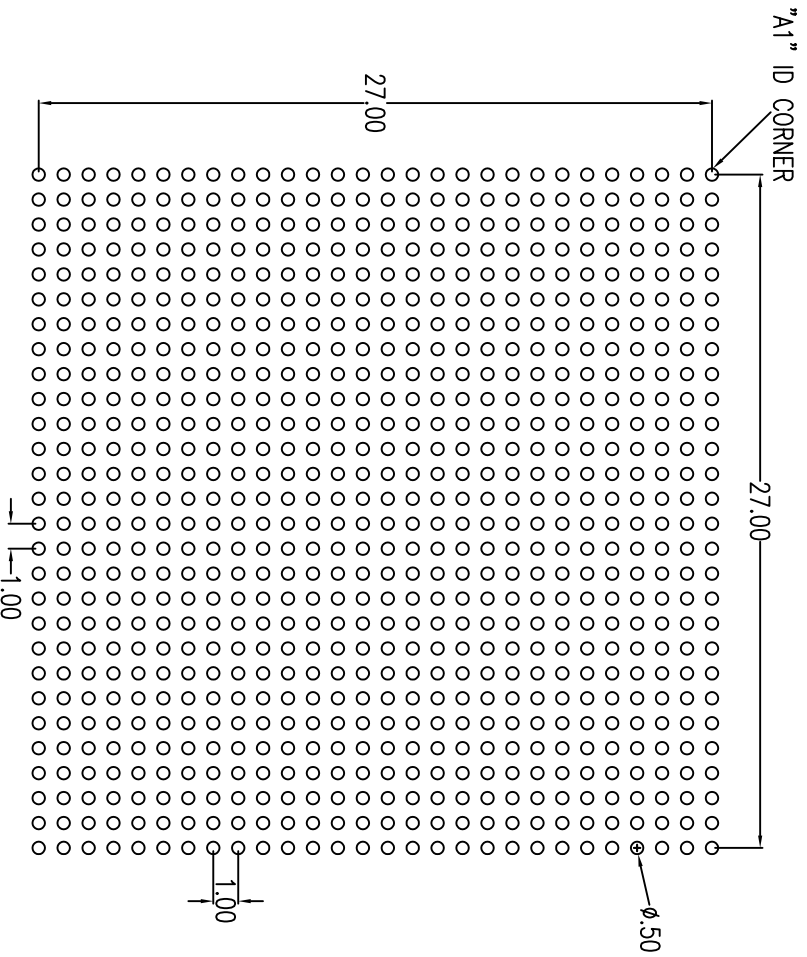
8024 Silver Creek Valley Rd
 San Jose, CA 95138
 PHONE: (408) 284-8200
 FAX: (408) 284-3572

TITLE HM/RM 784 PACKAGE OUTLINE
 FCBGA 29.0 x 29.0mm, 1.0mm pitch
 -Die Size: 9.82mm x 10.4mm-

SIZE C DRAWING NO. PSC-4277 REV 03

DO NOT SCALE DRAWING SHEET 1 OF 2

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	06/02/10	K. STAHN
01	PACKAGE THICKNESS UPDATED	06/15/10	K. STAHN
02	DIMENSIONS ADDED AND FORMAT UPDATED	10/06/10	M.ROY
03	COMBINE POD & LAND PATTERN	06/03/13	K. STAHN



RECOMMENDED LAND PATTERN DIMENSION (mm)

NOTE:

- 1) ALL dimensions are in mm, Angles in degrees.
- 2) Top down view, as view on PCB.
- 3) NSMD Land Pattern Assumed
- 4) Land Pattern Recommendation as per IPC-7351B generic requirement for surface mount design and Land Pattern.

TOLERANCES UNLESS SPECIFIED		DATE	
DECIMAL	ANGULAR	07/08/09	
XXX±	±		
XXXX			
XXXX±			
APPROVALS		TITLE	
DRAWN	DATE	HW/RM 784 PACKAGE OUTLINE	
07/08/09		FCBGA 29.0 x 29.0mm, 1.0mm pitch	
CHECKED		Die Size: 9.82mm x 10.4mm-	
		SIZE	REV
		C	03
		DRAWING NO.	
		PSC-4277	
DO NOT SCALE DRAWING		SHEET 2 OF 2	



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